

## SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER

Reverse Voltage - 50 to 1000 V

Forward Current - 2 A

### FEATURES

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- High efficiency
- Lead free in comply with EU RoHS 2011/65/EU directives

### MECHANICAL DATA

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg 0.00086oz

### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View  
Marking Code: US2A~US2M  
Simplified outline SMAF and symbol

### Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase half-wave 60 Hz, resistive or inductive load for capacitive load current derate by 20 %.

Parameter	Symbols	US2AF	US2BF	US2DF	US2GF	US2JF	US2KF	US2MF	Units					
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V					
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V					
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V					
Maximum Average Forward Rectified Current at $T_a = 65^\circ C$	$I_{F(AV)}$	2.0						A						
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	50						A						
Maximum Instantaneous Forward Voltage at 2 A	$V_F$	1.0		1.4		1.7		V						
Maximum DC Reverse Current $T_a = 25^\circ C$ at Rated DC Blocking Voltage $T_a = 125^\circ C$	$I_R$	5 100						$\mu A$						
Maximum Reverse Recovery Time <sup>1)</sup>	$t_{rr}$	50			75			ns						
Typical Thermal Resistance	$R_{\theta JA}$	50						$^\circ C/W$						
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150						$^\circ C$						

1) Measured with  $I_F = 0.5 A$ ,  $I_R = 1 A$ ,  $I_{rr} = 0.25 A$

Fig.1 Forward Current Derating Curve

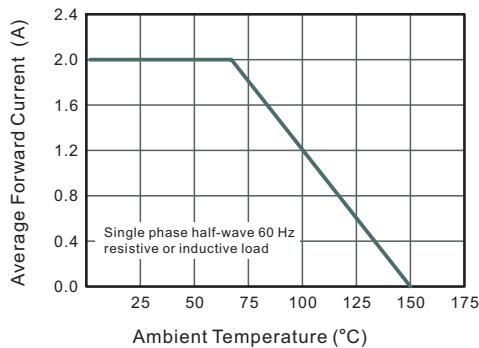


Fig.2 Typical Reverse Characteristics

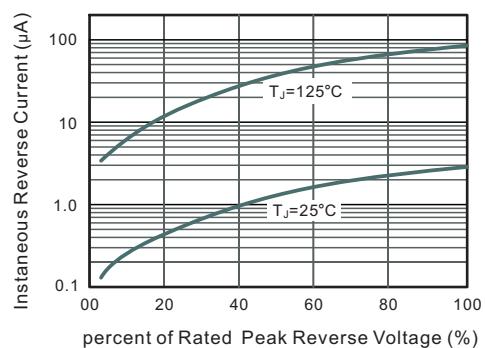


Fig.3 Typical Instaneous Forward Characteristics

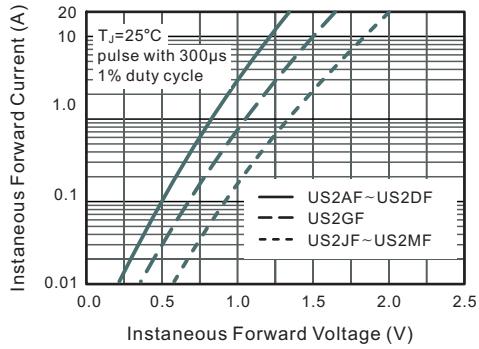
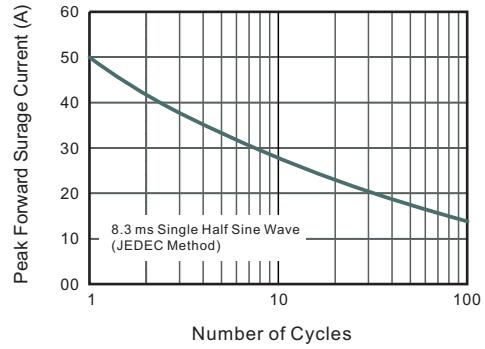


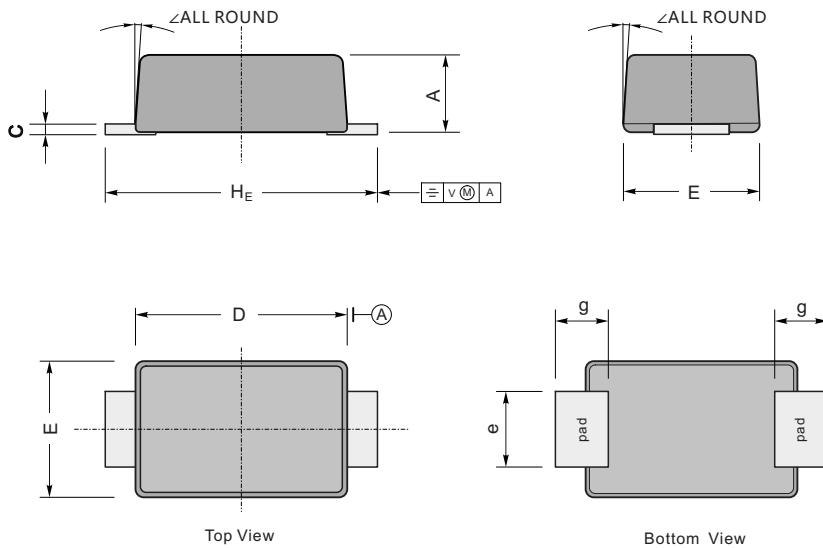
Fig.4 Maximum Non-Repetitive Peak Forward Surge Current



## PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMAF

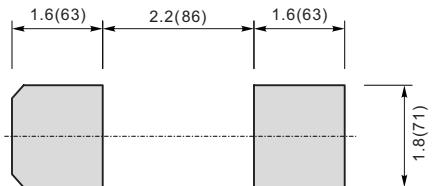


Top View

Bottom View

UNIT		A	C	D	E	e	g	H <sub>E</sub>	<
mm	max	1.1	0.20	3.7	2.7	1.6	1.2	4.9	7°
	min	0.9	0.12	3.3	2.4	1.3	0.8	4.4	
mil	max	43	7.9	146	106	63	47	193	7°
	min	35	4.7	130	94	51	31	173	

The recommended mounting pad size



Unit: mm(mil)